



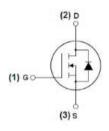
MJ N-Channel Enhancement Mode Power MOSFET

Description

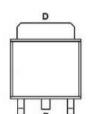
The MJ3080KA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $ightharpoonup V_{DS} = 30 V, I_{D} = 80 A$ $R_{DS(ON)} < 6.5 mΩ @ V_{GS} = 10 V$ $R_{DS(ON)} < 10 mΩ @ V_{GS} = 5 V$
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation







Application

◆ Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits

Marking and pin Assignment



TO-252-2L top view

100% UIS TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ3080KA	MJ3080KA	TO-252-2L	2	<u>=</u>	2

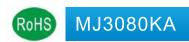
Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	80	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	50	А
Pulsed Drain Current	Ірм	170	А
Maximum Power Dissipation	PD	83	W
Derating factor		0.56	W/°C
Single pulse avalanche energy (Note 5)	Eas	306	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.8	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	30	_	-	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>		II.			
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	0.7	1.1	1.4	V
		V _{GS} =10V, I _D =30A	-	5.5	6.5	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =5V, I _D =24A	-	7.5	10	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =24A	20	-	-	S
Dynamic Characteristics (Note 4)					I	1
Input Capacitance	Clss		-	2330	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V F=1.0MHz	-	460	-	PF
Reverse Transfer Capacitance	Crss		-	230	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		_	20	-	nS
Turn-on Rise Time	tr	V _{DD} =10V,I _D =30A	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _{GEN} =2.7Ω	-	60	-	nS
Turn-Off Fall Time	tf	-	-	10	-	nS
Total Gate Charge	Qg		_	51	-	nC
Gate-Source Charge	Qgs	V _{DS} =10V,I _D =30A V _{GS} =10V	-	14	-	nC
Gate-Drain Charge	Q _{gd}	-	-	11	-	nC
Drain-Source Diode Characteristics	I					
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =30A	-	_	1.2	V
Diode Forward Current (Note 2)	ls		-	-	80	А
Reverse Recovery Time	trr	TJ=25°C, IF=30A	-	32	50	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	_	12	20	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is no	ealiaible(tı	ırn-on is d	ominated h	V I S+I D

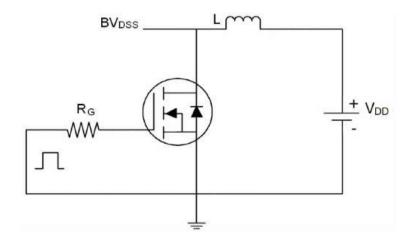
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- (4) Guaranteed by design, not subject to production
- (§) EAS condition: Tj=25°C,Vop=15V,Vg=10V,L=0.5mH,Rg=25 Ω

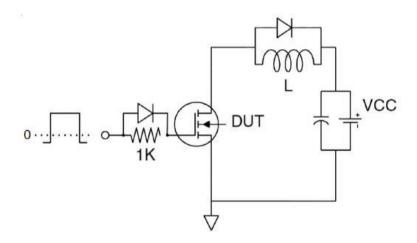




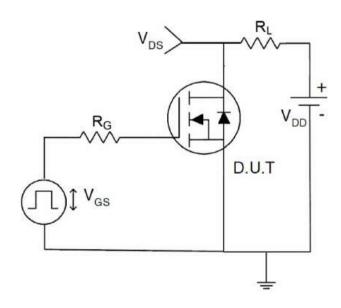
Test circuit



Eas test Circuit



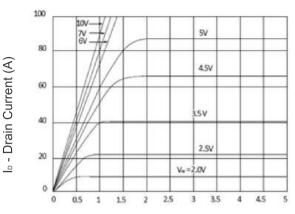
Gate charge test Circuit

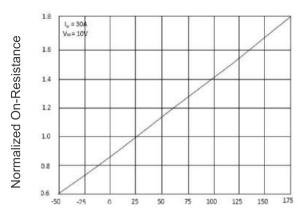


Switch Time Test Circuit



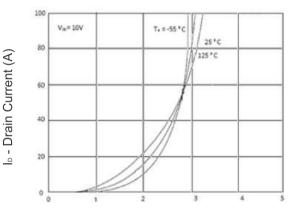
Typical Electrical and Thermal Characteristics (Curves)



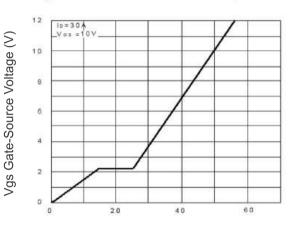


Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

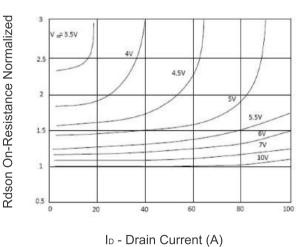


T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



Qg Gate Charge (nC) Figure 5 Gate Charge

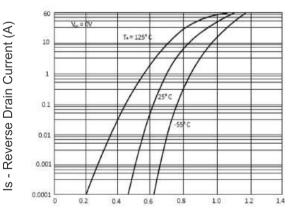


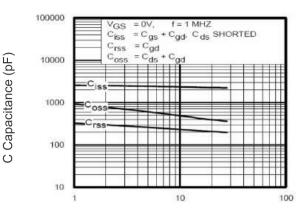
Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



lo - Drain Current (A)

Normalized BVdss

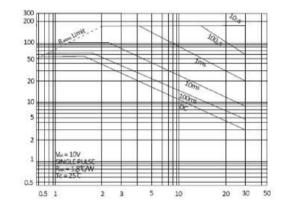


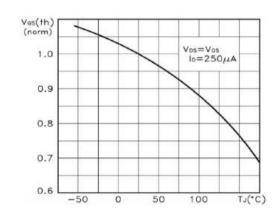
BV_{oss} (norm) V_{os=0} 1.2 1.1 1.0 0.9 0.8 -50 0 50 100 T_J(*C

Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

TJ -Junction Temperature(℃)

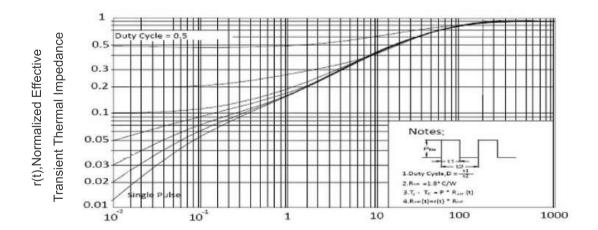
Figure 9 BVpss vs Junction Temperature





Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

T_J -Junction Temperature(°C)
Figure 10 V_{GS(th)} vs Junction Temperature



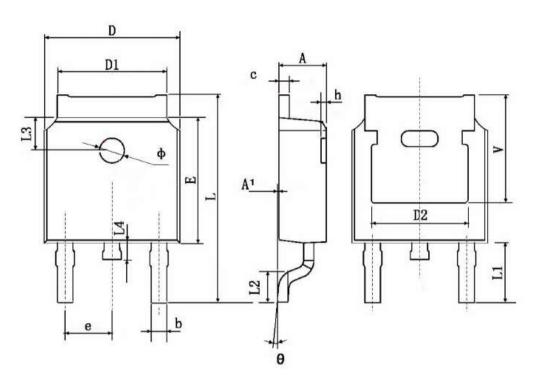
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



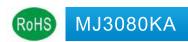


TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350	TYP.	0.211	TYP.





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